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SPECIFICATION

Revision: 0.0

WKS50WV028-WCT

This module uses ROHS material

This specification may change without prior notice in order to improve performance or quality. Please contact WKS R&D department for updated specification and product status before design for this product or release of this order.

WRITTEN BY	CHECKED BY	APPROVED BY		
Jason	Eric	Sandy		

TOUCH MODULE WKS50WV028-WCT

Revision:0.0

Apr 9, 2022

REVISION RECORD

REV NO.	REV DATE	CONTENTS	REMARKS
0.0	2022-4-9	First release	Preliminary

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1、GENERAL INFORMATION

Item of general information	Contents	Unit
LCD Display Size (Diagonal)	5.0	inch
LCD Display Type	TFT/TRANSMISSIVE	-
LCD Display Mode	Normally Black	-
Recommended Viewing Direction	ALL VIEW	o'clock
LCM Module size (W×H×T)	120.70×75.80×7.78	mm
Active area (W×H)	108.00×64.80	mm
Number of pixels (Resolution)	800×480	pixel
Pixel pitch (W×H)	0.135×0.135	mm
Color Pixel Arrangement	RGB Stripe	-
Interface Type	MIPI DSI interface	-
Color Numbers	16.7M	-
Backlight Type	White LED	-

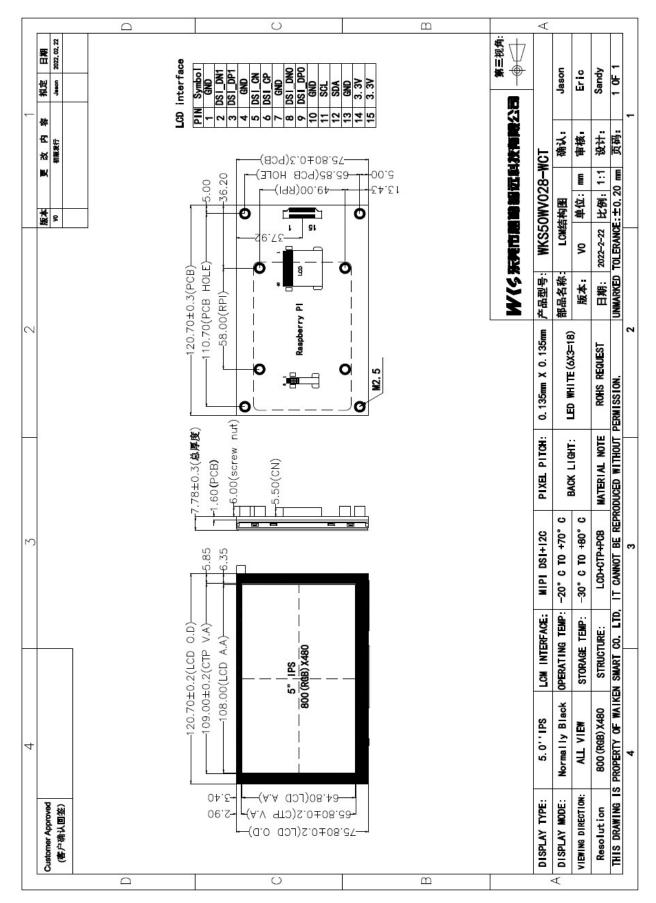
TOUCH MODULE

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2 EXTERNAL DIMENSIONS

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3、ABSOLUTE MAXIMUM RATINGS

Parameter of absolute maximum ratings	Symbol	Min	Max	Unit
LCD supply voltage	VDD	-0.5	5.0	V
Operating temperature	Тор	-20	70	°C
Storage temperature	Tst	-30	80	°C
Humidity	RH	-	90%(Max 60°C)	RH

Note: Absolute maximum ratings mean the product can withstand short-term, not more than 120 hours. If the product is a long time to withstand these conditions, the life time would be shorter.

4 LECTRICAL CHARACTERISTICS(DC CHARACTERISTICS)

Parameter of DC characteristics	Symbol	Min.	Тур.	Max.	Unit	Note
Power Supply Voltage	VDD	-	3.3	-	V	

5 CTP CHARACTERISTICS

Item of CTP characteristics	Specification	Unit	Remark
Panel Type	Glass Cover + Glass Sensor	-	-
Resolution	800 imes 480	pixel	-
Surface Hardness	6Н	-	-
Interface Type	I2C	-	-
Support Points	5	-	-

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6、ELECTRO-OPTICAL CHARACTERISTICS

Item of electro-optical characteristics		Symbol	Condition	Min.	Typ.	Max.	Unit	Remark	Note
Response	time	Tr+Tf	0.0	-	25	50	ms	FIG 1.	4
Contrast I	Ratio	CR	$ heta{=}0 \\ arnotheta{=}0$	-	500	-	-	<i>FIG 2</i> .	1
Luminance un	iformity	<i>SWHITE</i>	$Ta=25^{\circ}C$	-	80	-	%	<i>FIG 2</i> .	3
Surface Lum	inance	Lv	10 20 0	-	300	-	cd/m2	<i>FIG 2</i> .	2
CIE (x, y)	White	White x	$ heta{=}0 \ heta{=}0$	0.26	0.31	0.36		FIG 2.	5
chromaticity	wniie	White y	$Ta=25^{\circ}C$	0.28	0.33	0.38	-		
	Ø=90(1	2 o'clock)		-	80	-	deg		
Viewing	Ø=270((6 o'clock)	$CR \ge 10$	-	80	-	deg	FIG 3.	
angle range	Ø=0(3	o'clock)	$CK \ge 10$	-	80	-	deg	<i>Г</i> 10 3 .	6
	Ø=180(9 o'clock)		-	80	-	deg		
NTSC ratio		-	-	-	50	-	%	-	-

Note 1. Contrast Ratio(CR) is defined mathematically by the following formula. For more information see FIG 2.:

Contrast Ratio(CR) = $\frac{\text{Average Surface Luminance with all white pixels(P1, P2, P3, P4, P5, P6, P7, P8, P9)}{\text{Average Surface Luminance with all black pixels(P1, P2, P3, P4, P5, P6, P7, P8, P9)}$

Note 2. Surface luminance is the LCD surface from the surface with all pixels displaying white. For more information see FIG 2.

Lv=Average Surface Luminance with all white pixels (P1,P2,P3,P4,P5,P6,P7,P8,P9)

Note 3. The uniformity in surface luminance $(\delta WHITE)$ is determined by measuring

luminance at each test position 1 through 9, and then dividing the maximum luminance of

9points luminance by minimum luminance of 9 points luminance. For more information see

FIG 2.

Note 4. Response time is the time required for the display to transition from White to black(Rise Time, Tr) and from black to white(Decay Time, Tf). For additional information see FIG 1.

Note 5. CIE (x, y) chromaticity ,The x,y value is determined by screen active area position 5. For more information see FIG 2.

Note 6. Viewing angle is the angle at which the contrast ratio is greater than a specific value. For TFT module, the specific value of contrast ratio is 10.The angles are determined for the horizontal or x axis and the vertical or y axis with respect to the z axis which is normal to the LCD surface. For more information see FIG 3.

Note 7. For Viewing angle and response time testing, the testing data is base on

Autronic-Melchers's ConoScope. Series Instruments. For contrast ratio, Surface Luminance,

Luminance uniformity and CIE, the testing data is base on BM-7 photo detector.

Note 8. For TN type TFT transmissive module, Gray scale reverse occurs in the direction of panel viewing angle.

FIG.1. The definition of Response Time

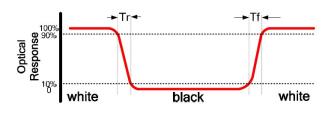


FIG.2. Measuring method for Contrast ratio, surface luminance, Luminance

uniformity, CIE (x , y) chromaticity

A:H/6;

H,V : Active Area(AA) size

Measurement instrument: BM-7; Light spot size=5mm, 350mm distance from the LCD surface to detector lens.

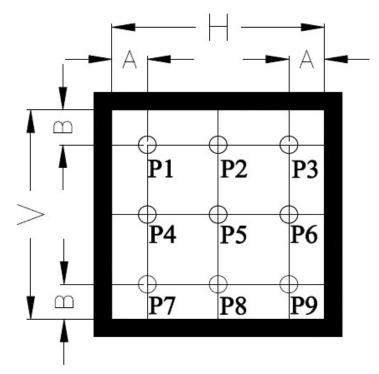
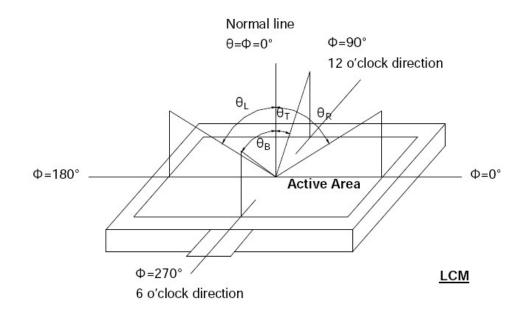


FIG.3. The definition of viewing angle



7、INTERFACE DESCRIPTION

NO.	Symbol	I/O	DESCRIPTION		
1	GND	Power	Ground		
2	DSI_DN1	Ι	MIPI DSI data1-		
3	DSI_DP1	Ι	MIPI DSI data1+		
4	GND	Power	Ground		
5	DSI_CN	Ι	MIPI DSI clock-		
6	DSI_CP	Ι	MIPI DSI clock+		
7	GND	Power	Ground		
8	DSI_DN0	Ι	MIPI DSI data0-		
9	DSI_DP0	Ι	MIPI DSI data0+		
10	GND	Power	Ground		
11	SCL	Ι	I2C data input and output for TOUCH		
12	SDA	I/O	I2C clock input for TOUCH		
13	GND	Power	Ground		
14	3.3V	Power	3.3V Power Input		
15	3.3V	Power	3.3V Power Input		

8、 RELIABILITY TEST CONDITIONS

No.	Test Item	Test Condition
1	High Temperature Storage	80°C/120 hours
2	Low Temperature Storage	-30°C/120 hours
3	High Temperature Operating	70°C/120 hours
4	Low Temperature Operating	-20°C/120 hours
5	Temperature Cycle Storage	-20°C(30min.)~25(5min.)~70°C(30min.)×10cycles

A. Inspection after test:

Inspection after 2~4 hours storage at room temperature, the sample shall be free from defects:

- Air bubble in the LCD;
- ➤ Sealleak;
- Non-display;
- Missing segments;
- ➢ Glass crack;
- Current is twice higher than initial value.

B、Remark:

- > The test samples should be applied to only one test item.
- > Sample size for each test item is $5 \sim 10$ pcs.
- Failure Judgment Criterion: Basic Specification, Electrical Characteristic, Mechanical Characteristic, Optical Characteristic.

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9、INSPECTION CRITERION

This specification is made to be used as the standard of acceptance/rejection criteria for TFT-LCD/IPS TFT-LCD module product, and this specification is applicable only in the case that the size of module equal to or exceed than 4.3 inch.

9.1 Sample plan

Sampling plan according to GB/T2828.1-2003/ISO 2859-1: 1999 and ANSI/ASQC

Z1.4-1993,normal level 2 and based on:

Major defect: AQL 0.65

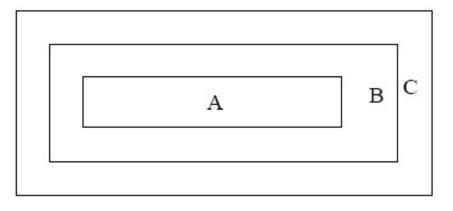
Minor defect: AQL 1.5

9.2 Inspection condition

Viewing distance for cosmetic inspection is about 30cm with bare eyes, and under an environment of 20~40W light intensity, all directions for inspecting the sample should be within 45° against perpendicular line. (Normal temperature 20~25°C and normal humidity 60 ± 15 %RH)

9.3 Definition of Inspection Item.

A. Definition of inspection zone in LCD.



Zone A: character/Digit area

Zone B: viewing area except Zone A (Zone A + Zone B=minimum Viewing area)

Zone C: Outside viewing area (invisible area after assembly in customer's product)

Fig.1 Inspection zones in an LCD

Note: As a general rule, visual defects in Zone C are permissible, when it is no trouble for

quality and assembly of customer's product.

B, Definition of some visual defect

	Because of losing all or part function, bad pixel dots appear bright and the			
Bright dot	size is more than 50% of one dot in which LCD panel is displaying under			
	black pattern.			
Deals 1-4	Dots appear dark and unchanged in size in which LCD panel is displaying			
Dark dot	under pure red, green, blue picture, or pure whiter picture.			

9.4 Major Defect

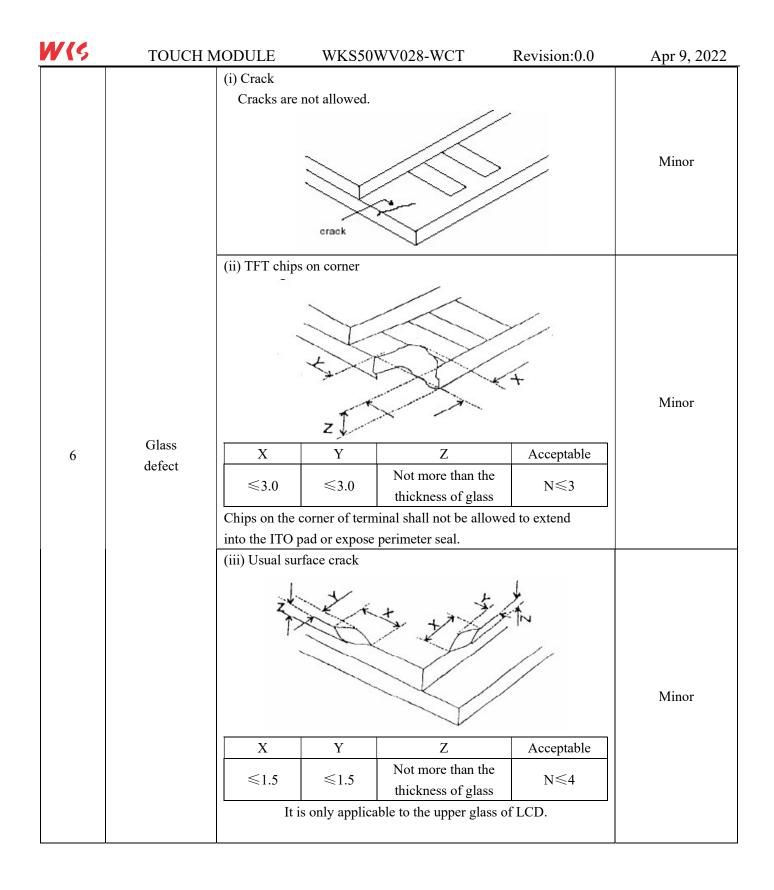
Item No.	Items to be inspected	Inspection standard	Classification of defects
1	Functional defects	 No display Display abnormally Missing vertical, horizontal segment Short circuit Excess power consumption Backlight no lighting, flickering and abnormal lighting 	major
2	Missing	Missing component	
3	Outline dimension	Overall outline dimension beyond the drawing is not allowed	

9.5 Minor Defect

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Item No.	Items to be inspected		Inspection standard													
		Zone			Aco	cepta	ble Qty									
					A	∧+B										
				4.3~7	7" 7~	10.1"	>10.1"	С								
		Bright pixel de	ot	1		2	3									
	Bright dot	Dark pixel do	t	4		4	4	Acc								
1	/dark dot	2bright dots adj	acent	0		0	0	Acceptable	Minor							
	defect	2dark dots adja	cent	0		0	0	able								
		Total bright and da	ark dots	5		6	7									
		Note: Minimum dis	tance bet	ween o	defective	dots	is more than	5mm;								
		Pixel dots' function	is norma	al, but I	bright do	ts cai	used by foreig	'n								
		material and other r	easons ai	re judg	ed by the	dot o	defect of 5.2.									
		Zone			Accepta	able	Qty									
	Dot defect $\downarrow y$ $\downarrow x$ $\Phi = (x+y)/2$		A+B													
		Dot defect	Dot defect	Dot defect	Dot defect	Dot defect	Dot defect		Size(mm)	4.3"~	~7"	7~10.1	"	>10.1"	С	
								Φ≤0.2	Accept	table	Accepta	ble	Acceptable	Acc		
2			$0.2 \! < \! \Phi \! \leqslant \! 0.5$	4		5		6	Acceptable	Minor						
		Φ>0.5	0	0 0		0	le									
		$\Phi = (x+y)/2$ Note: 1. Minimum distance between defective dots is more than 5 mm; 2. The quantity of defect is zero in operating condition.					m;									
		Zone			Accepta	able	Qty									
		Size (mm)			A+B											
3	Linear	Length Width	4.3"~	~7"	7~10.1	,,,	>10.1"	С	Minor							
5	defect	Ignore W≤0.05	Accept	table	Accepta	ble	Acceptable	Ac	TATILIO1							
		$ \begin{array}{ c c c } L \leqslant 5.0 & 0.05 < \\ W \leq 0.1 \end{array} $	4		5		6	Acceptable								
		L>5.0 W>0.1	0		0		0	le								

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4	Polarizer defect	(i) Shiftin dimension (ii) Incor allowed. 5.4.2 Dirt Dirt which 5.4.3 Pola Size(mm $\Phi \leq$ 0.2 < 0 (i) If the or in the (ii) If the	n. mplete cov on polariz h can be w mizer Dent Zone $\overline{2}$ 	on should not ering of the vi er iped easily sho & Air bubble 4.3"~7" Acceptable 4 0 atch scratch can b condition, ju	ewing area du ould be accept Acceptable A+B $7\sim10.1$ " Acceptable 5 0 e seen after oudge by the line be seen only	table. Qty >10.1" Acceptable 6 0 cover assemb inear defect of in non-opera ine following:	C Acceptable oling of 5.3.	Minor
5	MURA	Using	Minor					
	White/Black dot (MURA)	V 0.15						



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9.6 Module Cosmetic Criteria

Item No.	Items to be inspected	Inspection Standard	Classification of defects
1	Difference in Spec.	Not allowable	Major
2	Pattern peeling	No substrate pattern peeling and floating	Major
3		No soldering missing	Major
	Soldering defects	No soldering bridge	Major
		No cold soldering	Minor
4	Resist flaw on PCB	Visible copper foil (Φ 0.5 mm or more) on substrate	Minor
4	Resist flaw on PCB	pattern is not allowed	winor
5	FPC gold finger	No dirt, breaking, oxidation lead to black	Major
6	Backlight plastic frame	No deformation, crack, breaking, backlight positioning column breaking, obvious nick.	Minor
7	Marking printing effect	No dark marking, incomplete, deformation lead to unable to judge	Minor
8	Accretion of metallic Foreign matter	No accretion of metallic foreign matter (Not exceed Φ 0.2mm)	Minor
9	Stain	No stain to spoil cosmetic badly	Minor
10	Plate discoloring	No plate fading, rusting and discoloring	Minor
	1. Lead parts	a. Soldering side of PCB Solder to form a 'Filet' all around the lead. Solder should not hide the lead form perfectly.	Minor
		b. Components side(In case of 'Through Hole PCB') Solder to reach the Components side of PCB.	Minor
	2. Flat packages	Either 'Toe'(A) or 'Seal'(B)of the lead to be covered by "Filet". Lead form to be assume over Solder.	Minor
11	3. Chips	nips $(3/2) H \ge h \ge (1/2) H$	
	4. Solder ball/Solder splash	a. The spacing between solder ball and the conductor or solder pad h \geq 0.13 mm. The diameter of solder ball d \leq 0.15 mm.	Minor
		b. The quantity of solder balls or solder splashes isn't beyond 5 in 600 mm2.	Minor
		c. Solder balls/Solder splashes do not violate minimum electrical clearance.	Major